

New Product

Vishay Siliconix

N-Channel 75-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{(BR)DSS} (V)	$r_{DS(on)}\left(\Omega\right)$	I _D (A)			
75	0.007 at V _{GS} = 10 V	110			

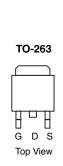
FEATURES

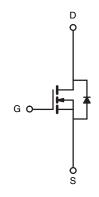
- TrenchFET[®] Power MOSFET
- · New Low Thermal Resistance Package



APPLICATIONS

- Automotive
 - Boardnet 42-VEP and ABS
 - Motor Drives
- High Current
- DC/DC Converters





Ordering Information: SUM110N08-07

SUM110N08-07-E3 (Lead (Pb)-free)

N-Channel MOSFET

ABSOLUTE MAXIMUM RATING	S T _A = 25 °C, un	less otherwis	se noted	
Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V _{DS}	75	V
Gate-Source Voltage		V _{GS}	± 20	v
Continuous Drain Current (T _J = 175 °C)	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 125 ^{\circ}{\rm C}$,	110	
	T _C = 125 °C	I _D	63 ^a	Α
Pulsed Drain Current		I _{DM}	350	^
Avalanche Current		I _{AR}	75	
Repetitive Avalanche Energy ^a	L = 0.1 mH	E _{AR}	280	mJ
Mariana Barra Birata di ad	$T_C = 25 ^{\circ}C$ $T_A = 25 ^{\circ}C^d$	D.	200 ^b	W
Maximum Power Dissipation ^a	T _A = 25 °C ^d	P _D	3.7	
Operating Junction and Storage Temperature Range		$T_{.l}, T_{sta}$	- 55 to 175	°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Limit	Unit	
Maximum Junction-to-Ambient	PCB Mount ^c	R _{thJA}	40	°C/W	
Maximum Junction-to-Case		R_{thJC}	0.75		

Notes

- a. Duty cycle \leq 1 %.
- b. See SOA curve for voltage derating.
- c. When mounted on 1" square PCB (FR-4 material).

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^{*} Pb containing terminations are not RoHS compliant, exemptions may apply

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SPECIFICATIONS $T_J = 25^{\circ}$						
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{DS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	75			V
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.5		4.0	
Gate Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
Zero Gate Voltage Drain Current		$V_{DS} = 75 \text{ V}, V_{GS} = 0 \text{ V}$		1		
	I _{DSS}	$V_{DS} = 75 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$			50	μΑ
		$V_{DS} = 75 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175 ^{\circ}\text{C}$			250	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	120			Α
Drain-Source On-State Resistance ^a		$V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}$		0.0055	0.007	
	r _{DS(on)}	$V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}, T_J = 125 \text{ °C}$		0.013		Ω
	, ,	$V_{GS} = 10 \text{ V, I}_{D} = 30 \text{ A, T}_{J} = 175 ^{\circ}\text{C}$			0.017	1
Forward Transconductance	9 _{fs}	V _{DS} = 15 V, I _D = 30 A	30			S
Dynamic ^b						
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz		5250		pF
Output Capacitance	C _{oss}			700		
Reverse Transfer Capacitance	C _{rss}			310		
Total Gate Charge ^c	Q _q			90	165	nC
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 35 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 110 \text{ A}$		24		
Gate-Drain Charge ^c	Q _{gd}			27		
Turn-On Delay Time ^c	t _{d(on)}			20	30	
Rise Time ^c	t _r	V_{DD} = 35 V, R_L = 0.4 Ω		100	150	ns
Turn-Off DelayTime ^c	t _{d(off)}	$I_D \cong 85 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 2.5 \Omega$		45	70	
Fall Time ^c	t _f	1		75	115	
Source-Drain Diode Ratings and Cha	racteristics (T _C	= 25 °C) ^b			<u>. </u>	
Continous Current	Is				110	А
Pulsed Current	I _{SM}				350	
Forward Voltage ^a	V _{SD}	I _F = 110 A, V _{GS} = 0 V		1.0	1.5	V
Reverse Recovery Time	t _{rr}	. 55		75	120	ns
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 85 A, di/dt = 100 A/μs		3.5	7	Α
Reverse Recovery Charge	Q _{rr}	,		0.13	0.30	μC

Notes

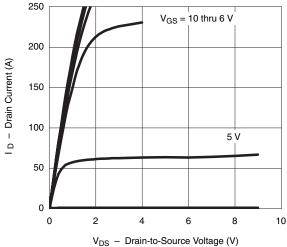
- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

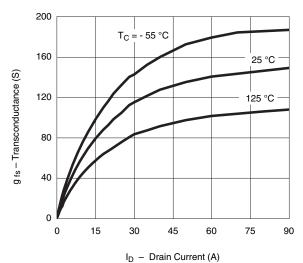


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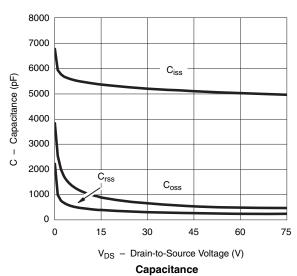
TYPICAL CHARACTERISTICS $T_A = 25$ °C, unless otherwise noted

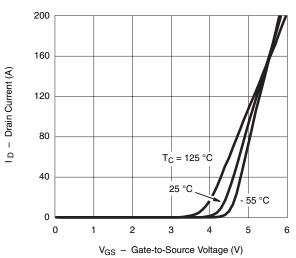


V_{DS} - Drain-to-Source Voltage (V Output Characteristics

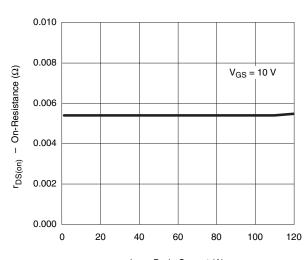


Transconductance



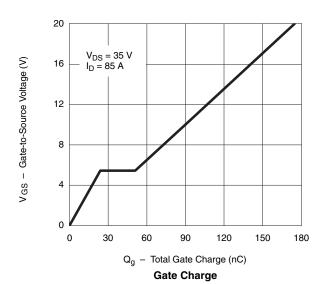


Transfer Characteristics



I_D - Drain Current (A)

On-Resistance vs. Drain Current



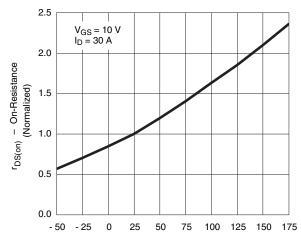
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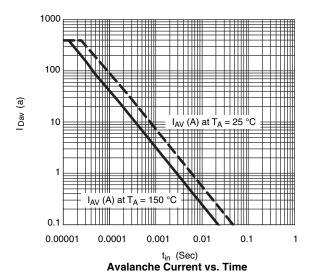
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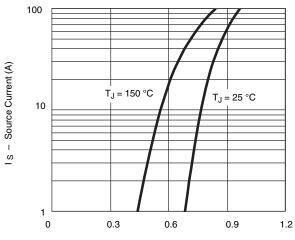


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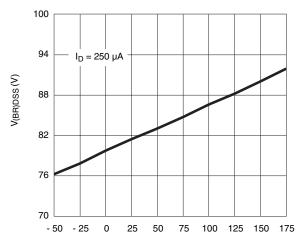


 $T_J - \mbox{Junction Temperature (°C)}$ On-Resistance vs. Junction Temperature





V_{SD} - Source-to-Drain Voltage (V)
Source-Drain Diode Forward Voltage



T_J – Junction Temperature (°C)

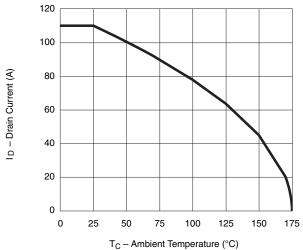
Drain Source Breakdown vs.

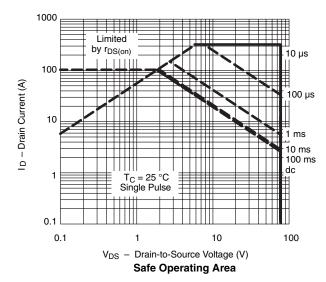
Junction Temperature

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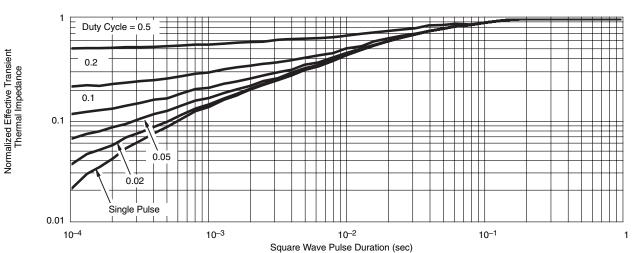
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TYPICAL CHARACTERISTICS $T_A = 25$ °C, unless otherwise noted





Maximum Avalanche and Drain Current vs. Case Temperature



Normalized Thermal Transient Impedance, Junction-to-Case

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